

Company Presentation February 2009



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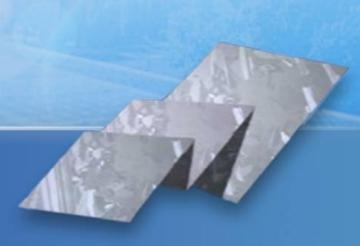
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Company Overview



LDK at a Glance



Company Description

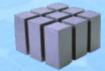
- Leading manufacturer of multicrystalline solar wafers.
- Expanding annualized wafer production capacity from 420MW at the end of 2007 to 1.20 GW by the end of the third quarter of 2008. Currently forecasting 1.46GW by the end of 2008, 2.0 GW by end of 2009 and 3.20 GW by end of 2010.
- Constructing in-house polysilicon facilities, with expected production of 3,000-5,000 MT in 2009.
- Diversified customer base mainly consisting of top PV cell and module manufacturers.

KOV	Figures
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£ US\$1MMunless nated otherwise)	4Q07	1Q08	2Q08	3Q08
Annual Capacity (MV)	420	580	880	1,200
Net Sales	\$192.8	\$233.4	\$441.7	\$541.8
Growth(%)	21.4%	21.1%	89.2%	22.7%
Gross Profit	58.0	64.6	112.3	122.9
Margin(%)	30.1%	27.7%	25.4%	22.7%
Operating Profit	46.7	52.5	100.3	107.8
Margin(%)	24.2%	22.5%	22.7%	19.9%
Net Income ⁽²⁾	49.2	49.8	149.5	88.4
Margin(%)	25.5%	21.3%	33.9%	16.3%
EPS (Diluted)	\$0.44	\$0.45	\$1.29	\$0.77









Silicon

Ingot and Block

Wafer

Note:

1 Net income is defined as the net income available to ordinary shareholders



Key Investment Highlights



- Leading Wafer Manufacturer with Rapid Capacity Expansion
- 2 Cost Leader in Wafer Manufacturing Industry
- 3 Diversified Global Customer Base with a Strong Sales Backlog
- 4 Continuous R&D efforts on Technological and Product Innovation

5 Upside Potential from In-house Polysilicon Production

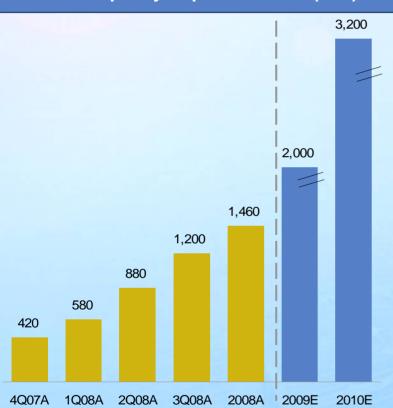




Leading Wafer Manufacturer with Rapid Capacity Expansion







Wafer Plant





Annualized wafer production capacity as of period/year end



Cost Leader in Wafer Manufacturing Industry



Economies of Scale	Cost reduction due to increase of production / capacity
Wafer Thickness Reduction	180-micron and 200-micron wafers in mass production
In-House Polysilicon Production	 Currently under construction and expected polysilicon production in 1Q09 Installed annual manufacturing capacity of 16,000MT by the end of 2009
Kerf Loss	120-micron wire thickness in trial production
Yield Improvement	Reduce wafer losses such as breakage
Geographic Advantage	 China-based operation Close proximity to crucible producer Jiangxi Sinoma & polysilicon plants
Crucible	 Crucible cost declining from 2Q08 Targeting 70% capacity from Jiangxi Sinoma by end of 4Q08
Domestic Furnace	 Exclusive partnership with JYT 800-KG loading furnace Lower CAPEX to ramp up 3.2 GW capacity in 2010
Slurry Recycling	In-house slurry recycling system in place
Wire Saw	Use new model wire saw



R&D Roadmap

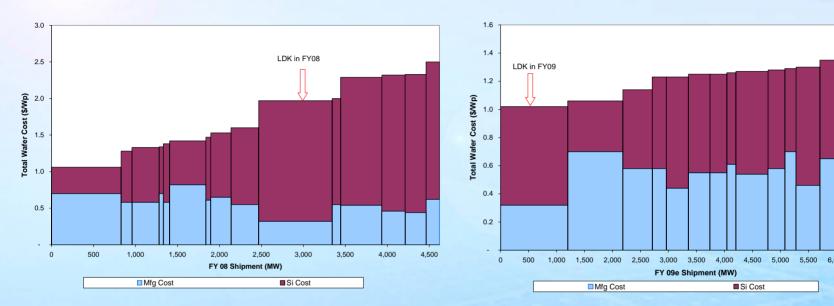


Parameter	2007	Current Status	Future Goals (2013)
Ingot Weight	270kg	450kg	1,000kg
Ingot Energy Consumption	9.2 kwh/kg	8.0 kwh/kg	6.0 kwh/kg
Wafer Size	156X156 (mm ²)	156X156 (mm²)	210X210 (mm²)
Wafer Thickness	220μm	180μm	120µm
Kerf Loss	175μm	155μm	130µm
Polysilicon Consumption	8-10 g/w	6-8 g/w	4-5 g/w
Cell Efficiency (with Customers)	15.3%	15.8%	18.0%



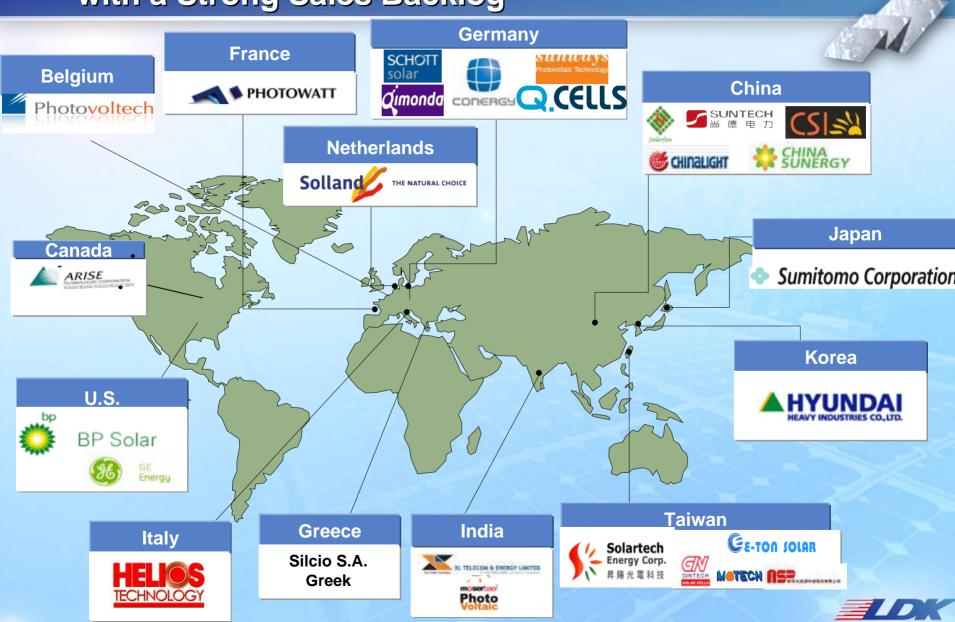
From Manufacturing Cost Leader to Total Cost Leader

Source: Morgan Stanley Research



- Continued cost reduction focus in 2009 and beyond
- In-house polysilicon supply starting in 2009
- Continued use of recycle silicon
- In-house slurry recovery starting in 2009
- Further reduction in silicon consumption/Wp. Wafer thickness, wire diameter

Diversified Global Customer Base with a Strong Sales Backlog





Diversified Global Customer Base with a Strong Sales Backlog

Recently Signed Contracts

November 14, 2008



October 20, 2008



October 17, 2008

US-based leading supplier

September 12, 2008

Q.CELLS

September 5, 2008

September 3, 2008

August 29, 2008

August 13, 2008

July 16, 2008

June 30, 2008

June 13, 2008

May 5, 2008

April 4, 2008

April 2, 2008















Solar PV Corporation



POMITON / Silcio S.A. Greek



- 3-year contract for 435 MW, commencing in 2009
- 7-year contract for 70 MW, commencing in 2009
- 3-year contract for 90 MW over 3-year, commencing in 2009
- 11-year processing service agreement to process minimum of 20,000 MT upgraded metallurgical grade (UMG) solar-grade silicon
- 8-year contract for 750 MW, commencing in 2009
- 5-year contract for 550 MW, commencing in 2009
- 7-year contract for 440 MW, commencing in 2009
- 5-year contract for 300 MW, commencing in 2009
- 10-year contract for 400 MW, commencing in 2009
- 10-year supply contract for 800 MW, commencing in 2009 Follow-on to 3 year contract signed in Oct. 2007
- 5-year supply contract for 70 MW, commencing in 2009
- 5-year supply contract for 540 MW, commencing in 2009
- 4-and 6-year contracts for an aggregate of less than 100 MW, both commencing in 2008
- 10-year supply contract for more than 640 MW, commencing in mid 2008





Diversified Global Customer Base with a Strong Sales Backlog

2009 - 2018 Backlog (in MW) (1)



- Strong customer demand from China, rest of Asia, Europe, and N. America
- Secured long term contracts, ranging from 5 to 10 years
- Backlog more than 14GW through 2018, with down payments from customers, plus 6GW of wafer processing order
- Customer demand strongly supports our manufacturing capacity expansion



Note (1): As of Nov.15, 2008, based on signed contracts.



Continuous R&D efforts on Technological and Product Innovation

Dedicated R&D efforts to secure cost competitive leadership



Production process enhancement

Cooperation with Jiaotong University

Locally-produced quality consumables and supplemental equipment



Cooperation with Nanchang University

Producing lower-cost consumables



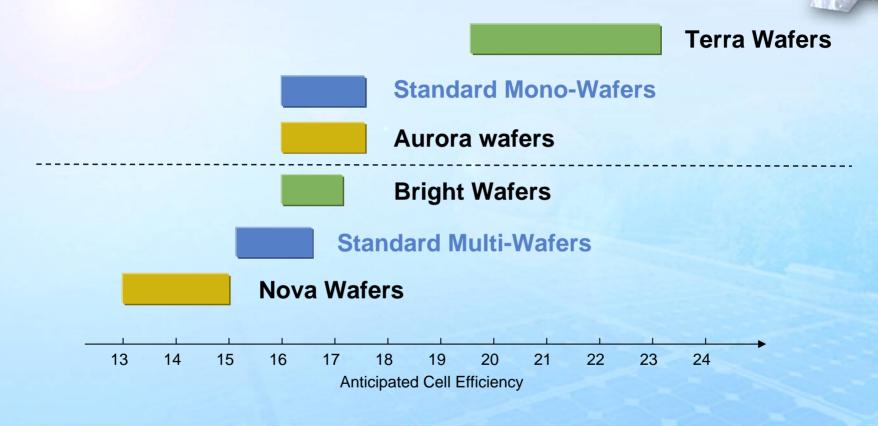
Improvement of manufacturing process

- Solidification purification process
- Ingot size
- Wafer thickness
- Polysilicon kerf loss
- Recycling of silicon material
- Use of domestic material





Continuous R&D efforts on Technological and Product Innovation



- Terra Wafers: N-type Mono-wafers for high-efficiency cells
- Aurora Wafers: Mono-crystalline wafers with innovative casting process
- Bright Wafers: Multi-crystalline wafers with improved quality
- Nova Wafers: Multi-crystalline wafers with UMG silicon



Upside Potential from In-house Polysilicon Production

Status Update

- 1,000 MT polysilicon plant is currently in production: LDK expects to increase annualized polysilicon production capacity to 2,000 MT from 1,000 MT by end of 2009 in order to improve its production cost structure.
- 15,000 MT polysilicon plant construction: first 5,000 MT train expected to reach mechanical completion at the end of the 2Q09; the second 5,000 MT train is expected to reach mechanical completion during 2H09.
- Plan to produce an aggregate 3,000-5,000 MT of polysilicon in 2009.

Announced Partnerships

EPCM



Equipment



Engineering Solutions

TCS



Management and Engineers

- Hired a senior team of 8 polysilicon engineers from China, Europe and USA
- Built a team of over 200 engineers and researchers







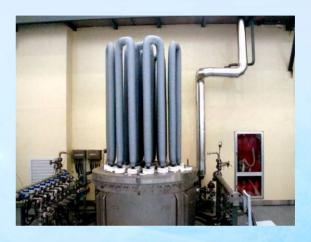
LDK 1,000 MT/Y Polysilicon Plant Update Jan. 16, 2009

















TCS Purification and Off Gas Recovery System

















Fire water pump station



Process control room



Compressed air



Cooling water pump station



Off-gas recovery system



Hydrogen System





TCS Distillation & CDI/OGR



Switchgear control room



TCS Distillation (Nightscape)



Switchgear Station







CVD Reactors (2)





LDK 15,000 MT/Y Polysilicon Plant Update
Jan. 30, 2009



Progress and Performance Jan.30, 2009

CATEGORY	PLAN	ACTUAL
Polysilicon Plant	74.9%	72.2%
TCS Plant	69.9%	58.7% Line 1. 95%
Utilities, Infrastructure	93.0%	87.0%
Total	80.9%	75.0%

Construction started November 25, 2007



Jan. 30, 2009 Update



Jan. 30, 2009 Update





Jan. 30, 2009 Update











Financial Overview

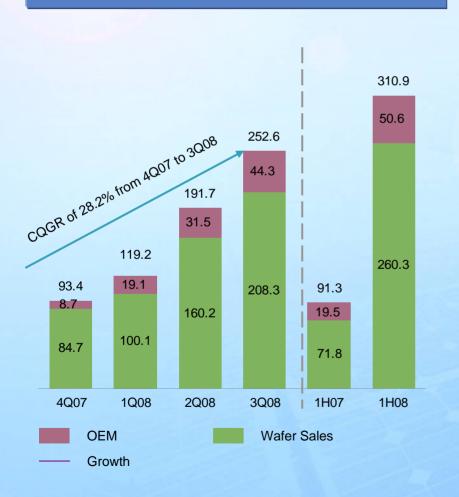


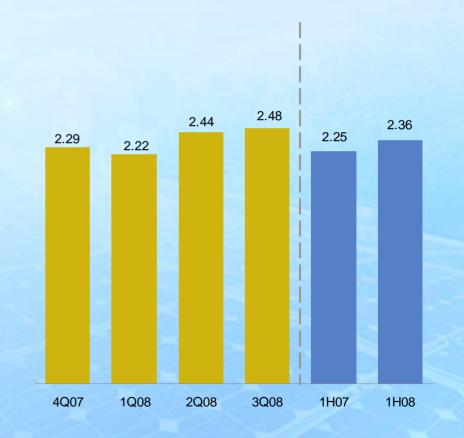
Wafer Shipment and ASP Trend







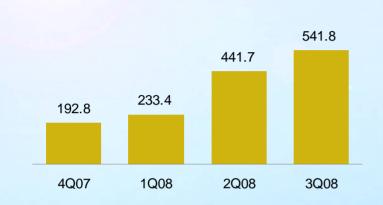






Financial Performance





Operating Profit (US\$ MM)



Gross Profit (US\$ MM)



Net Income⁽¹⁾ (US\$ MM)



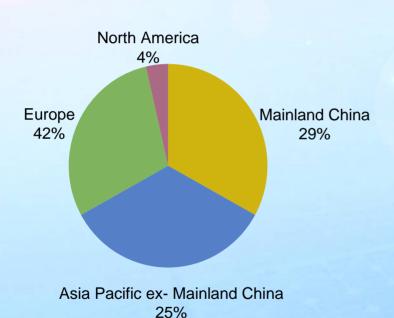


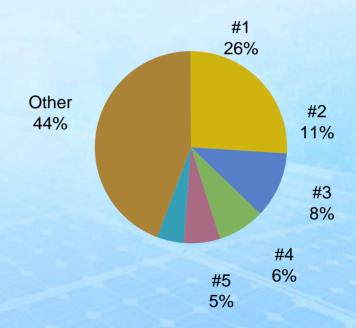
Top Customers by Revenue for 3Q08



By Geography

By Customer







Balance Sheet

LDK Solar Co., Ltd. Unaudited Condensed Consolidated Balance Sheet Information (In US\$'000)



	9/30/2008	6/30/2008	3/31/2008
Assets			
Cash and cash equivalents	347,762	83,742	93,705
Pledged bank deposits (1)	164,504	295,378	172,106
Inventories	709,992	666,731	540,995
Prepayments to suppliers (1)	316,937	274,344	226,864
Property, plant and equipment, net	1,138,539	705,784	501,078
Deposits for property, plant and equipments	301,252	222,400	200,725
Total assets	3,181,217	2,427,851	1,853,106
Total debt ⁽²⁾	1,011,405	874,792	351,728
Total debt ⁽²⁾ Leverage ratio ⁽³⁾	1,011,405 50.3%	874,792 55.6%	351,728 31.1%
Leverage ratio (3)			
Leverage ratio (3)	50.3%	55.6%	31.1%
Leverage ratio (3) Advance payments from customers (1)	50.3% 777,182	55.6% 607,668	31.1% 532,402

⁽¹⁾ Include both current and non-current portions



⁽²⁾ Total debt includes short-term and long-term interest-bearing borrowings

Total debt / (total debt + total shareholders'equity)

Financial Guidance (Updated on Feb. 18th 09)



4Q08

2008

Wafer Capacity

1.46GW

1.46GW

Wafer Shipment

245 MW - 255 MW

810 MW - 820 MW

Revenue

\$415 M - \$425 M

\$1.63 B - \$1.64 B

Net Profit / (Loss)

\$(135) M - \$(145) M

\$145 M - \$155 M



Our Growth Strategy



Broaden geographic presence and strengthen customer relationships

Develop in-house polysilicon manufacturing capabilities

Expand wafer production capacity to meet customer demand



Secure polysilicon feedstock supply from third party vendors

Improve R&D to reduce manufacturing costs, improve production yield and pursue technological innovation

Consider selective alliances and acquisitions

